

MAR 21 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 09/884,429 Confirmation No.: 9951  
Applicant(s) : David Chazan, et al.  
Filing Date : 06/18/2001  
TC/A.U. : 1743  
Examiner : Brian R. Gordon

Docket No. : 100/09110  
Customer No. : 021569  
Title : Methods and Devices for Enhancing Bonded Substrate Yields and  
Regulating Temperature

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed September 21, 2004, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims that begins on page 2 of this paper.

**Amendments to the Drawings** begin on page 10 of this paper and include an attached replacement sheet(s).

**Remarks/Arguments** begin on page 11 of this paper.

An Appendix including amended drawing figures is attached following page 12 of this paper.